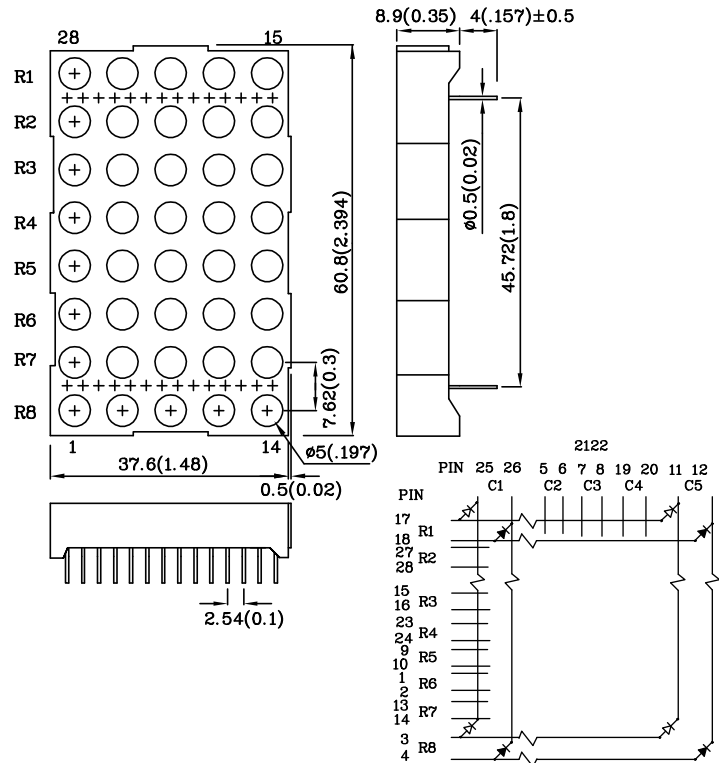


### Features

- 2.4 INCH MATRIX HEIGHT.
- DOT SIZE 5mm.
- LOW CURRENT OPERATION.
- HIGH CONTRAST AND LIGHT OUTPUT.
- COMPATIBLE WITH ASCII AND EBCDIC CODES.
- STACKABLE HORIZONTALLY.
- EASY MOUNTING ON P.C. BOARDS OR SOCKETS.
- MULTICOLOR AVAILABLE.
- MECHANICALLY RUGGED.
- STANDARD : GRAY FACE, WHITE DOT.
- RoHS COMPLIANT.

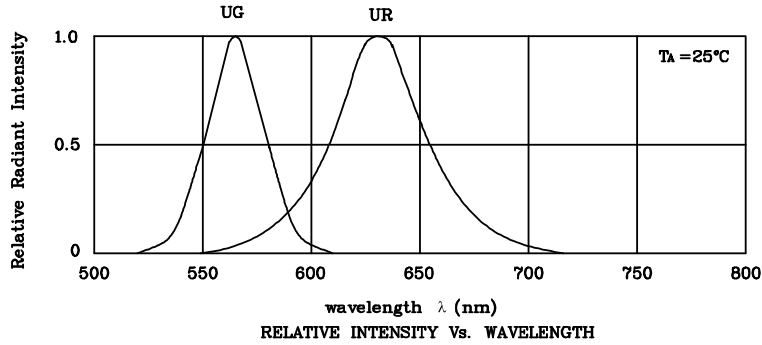


### Notes:

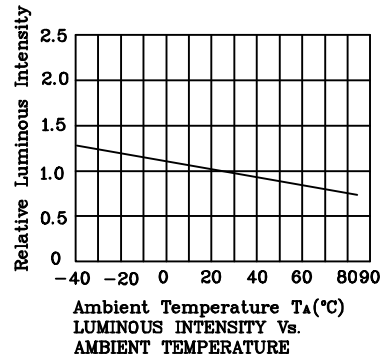
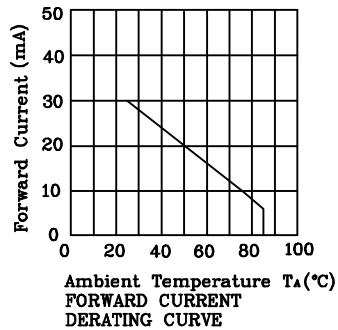
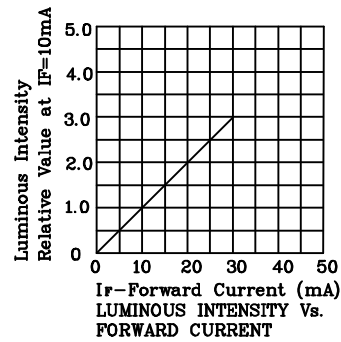
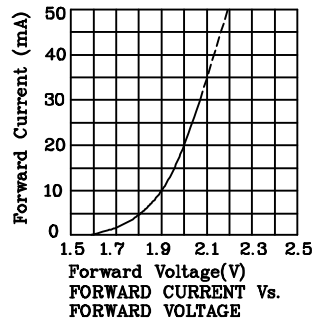
1. All dimensions are in millimeters (inches).
2. Tolerance is  $\pm 0.25(0.01")$  unless otherwise noted.

Absolute Maximum Ratings ( $T_A=25^\circ\text{C}$ )		UR (GaAsP/ GaP)	UG (GaP)	Unit	Operating Characteristics ( $T_A=25^\circ\text{C}$ )		UR (GaAsP/ GaP)	UG (GaP)	Unit
Reverse Voltage	$V_R$	5	5	V	Forward Voltage (Typ.) ( $I_F=10\text{mA}$ )	$V_F$	1.9	2.0	V
Forward Current	$I_F$	30	25	mA	Forward Voltage (Max.) ( $I_F=10\text{mA}$ )	$V_F$	2.5	2.5	V
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	$i_{FS}$	160	140	mA	Reverse Current ( $V_R=5\text{V}$ )	$I_R$	10	10	$\mu\text{A}$
Power Dissipation	$P_T$	105	105	mW	Wavelength of Peak Emission ( $I_F=10\text{mA}$ )	$\lambda_P$	627	565	nm
Operating Temperature	$T_A$	-40 ~ +85		°C	Wavelength of Dominant Emission ( $I_F=10\text{mA}$ )	$\lambda_D$	625	568	nm
Storage Temperature	$T_{stg}$	-40 ~ +85			Spectral Line Full Width At Half-Maximum ( $I_F=10\text{mA}$ )	$\Delta\lambda$	45	30	nm
Lead Solder Temperature [2mm Below Package Base]	260°C For 5 Seconds				Capacitance ( $V_F=0\text{V}$ , $f=1\text{MHz}$ )	$C$	15	15	pF

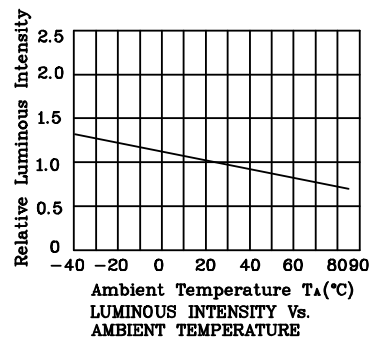
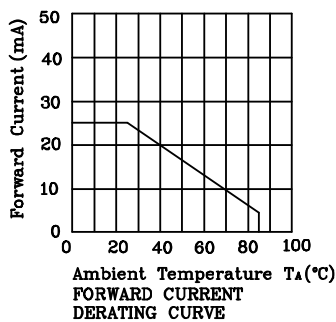
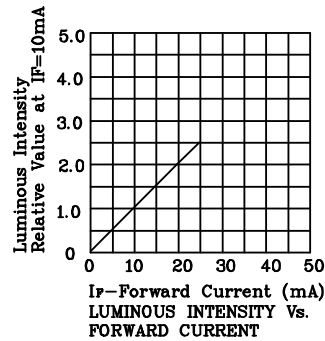
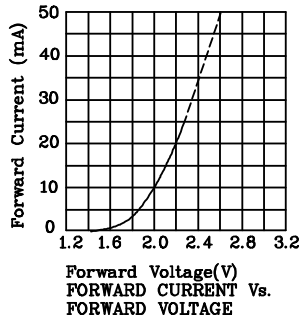
Part Number	Emitting Color	Emitting Material	Luminous Intensity ( $I_F=10\text{mA}$ ) ucd		Wavelength nm $\lambda_P$	Description
			min.	typ.		
XMURG60C-1A	Red	GaAsP/GaP	1900	7990	627	Column Cathode
	Green	GaP	3000	11990	565	



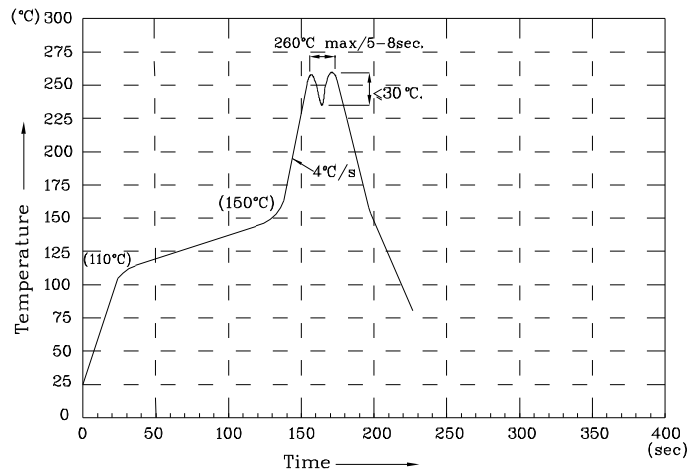
❖ UR



❖ UG



Wave Soldering Profile For Lead-free Through-hole LED.



NOTES:

- 1.Recommend the wave temperature 245°C~260°C.The maximum soldering temperature should be less than 260°C.
- 2.Do not apply stress on epoxy resins when temperature is over 85 degree°C.
- 3.The soldering profile apply to the lead free soldering (Sn/Cu/Ag alloy).
- 4.No more than once.

Remarks:

If special sorting is required (e.g. binning based on forward voltage, luminous intensity, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm
2. Luminous Intensity: +/-15%
3. Forward Voltage: +/-0.1V

Note: Accuracy may depend on the sorting parameters.